

isc N-Channel MOSFET Transistor

IXFH15N100Q3

• FEATURES

- Drain Source Voltage-
: $V_{DSS}=1000V$ (Min)
- Static Drain-Source On-Resistance
: $R_{DS(on)}=1.0\ \Omega$ (Max)
- 100% avalanche tested
- Minimum Lot-to-Lot variations for robust device performance and reliable operation

• APPLICATIONS

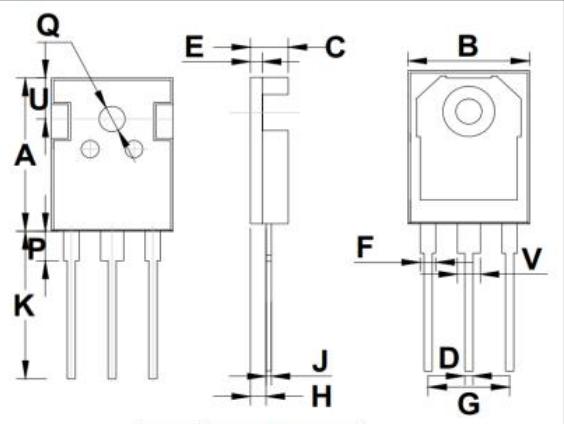
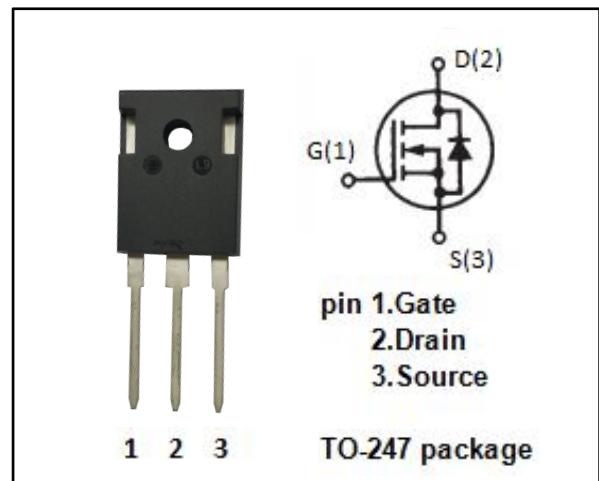
- Switching applications

• ABSOLUTE MAXIMUM RATINGS($T_a=25^\circ C$)

SYMBOL	PARAMETER	VALUE	UNIT
V_{DSS}	Drain-Source Voltage	1000	V
V_{GSS}	Gate-Source Voltage	± 30	V
I_D	Drain Current-Continuous	15	A
I_{DM}	Drain Current-Single Pulsed	45	A
P_D	Total Dissipation	690	W
E_{AS}	$T_c = 25^\circ C$	1.0	J
T_j	Operating Junction Temperature	-55~150	°C
T_{stg}	Storage Temperature	-55~150	°C

• THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	MAX	UNIT
$R_{th(ch-c)}$	Channel-to-case thermal resistance	0.19	°C/W



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ELECTRICAL CHARACTERISTICS

T_c=25°C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V; I _D = 1mA	1000	-	-	V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =±30V; I _D =2.5mA	2.5	-	4.5	V
R _{DS(on)}	Drain-Source On-Resistance	V _{GS} = 10V; I _D =7.5A	-	-	1.0	Ω
I _{GSS}	Gate-Source Leakage Current	V _{GS} = ±30V; V _{DS} = 0V	-	-	±0.1	μ A
I _{DSS}	Drain-Source Leakage Current	V _{DS} = 1000V; V _{GS} =0V; @T _c =25°C	-	-	25	μ A

Dynamic Characteristics

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
C _{iss}	Input Capacitance	V _{GS} = 0V, V _{DS} = 25V, f = 1.0MHz	-	3750	-	pF
C _{oss}	Output Capacitance		-	240	-	
C _{rss}	Reverse Transfer Capacitance		-	30	-	

Resistive Switching Characteristics

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
Q _g	Total Gate Charge	V _{DD} = 48V, I _D = 60A, V _{GS} = 10V	-	73	-	nC
Q _{gs}	Gate-Source Charge		-	16	-	
Q _{gd}	Gate-Drain Charge		-	27	-	
t _{d(on)}	Turn-on Delay Time	V _{DD} = 40V, I _D = 60A, R _G = 25Ω	-	35	-	ns
t _r	Turn-on Rise Time		-	36	-	
t _{d(off)}	Turn-off Delay Time		-	44	-	
t _f	Turn-off Fall Time		-	35	-	

isc N-Channel MOSFET Transistor**IXFH15N100Q3****Drain - Source Body Diode Characteristics**

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
I _{SD}	Continuous Source Current	T _c = 25 °C	-	-	15	A
I _{SM}	Pulsed Source Current		-	-	45	
V _{SD}	Diode Forward Voltage	I _{SD} = 15A; V _{GS} = 0V	-	-	1.4	V
t _{rr}	Reverse Recovery Time	I _F = 15A, dI _F /dt = 100A /μs	-	850	-	ns
Q _{rr}	Reverse Recovery Charge		-	4.4	-	uC

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